



# YETDA INDUSTRY LTD.

## Technical Data Sheet

MODEL NO : Q776Y4-50mA

3528 Package 3.5 x 2.8mm TOP LED

### Features :

- Lens Molding
- Compatible with automatic placement equipment
- Compatible with reflow solder process

### Applications :

- Indicators
- Automotive : backlighting in dashboard and switch
- Backlight for LCD

Dice material	Emitted color	Lens Color
AlGaInP	Yellow	Water transparent

### Electrical/Optical Characteristics(Ta=25°C )

Parameter	Test Condition	Symbol	Value			Unit
			Min	Typ	Max	
Wavelength at peak emission	IF=50mA	△ λ		20		nm
Dominant wavelength	IF=50mA	λ D	585	590	595	nm
Forward voltage	IF=50mA	V <sub>F</sub>	1.8	2.2	2.5	V
Luminous intensity	IF=50mA	I <sub>V</sub>	3200	6500	11200	mcd
Viewing angle at 50% I <sub>V</sub>	IF=50mA	2θ 1/2		25		Deg
Reverse current	V <sub>R</sub> =5V	I <sub>R</sub>			10	μA

### Absolute Maximum Ratings(Ta=25°C )

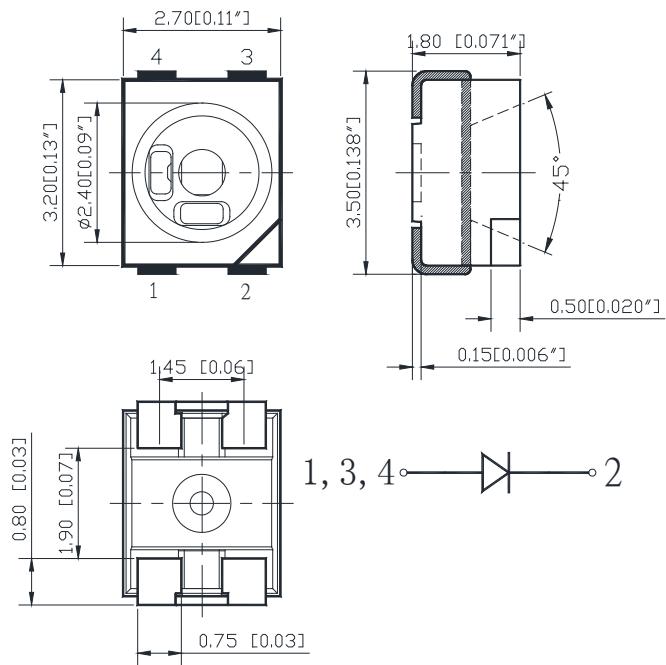
Parameter	Symbol	Value	Unit
Power dissipation	P <sub>d</sub>	170	mW
Forward current	I <sub>F</sub>	70	mA
Reverse voltage	V <sub>R</sub>	5	V
Operating temperature range	T <sub>op</sub>	-40 ~+80	°C
Storage temperature range	T <sub>stg</sub>	-40 ~+85	°C
Peak pulsing current (1/8 duty f=1kHz)	I <sub>fp</sub>	125	mA

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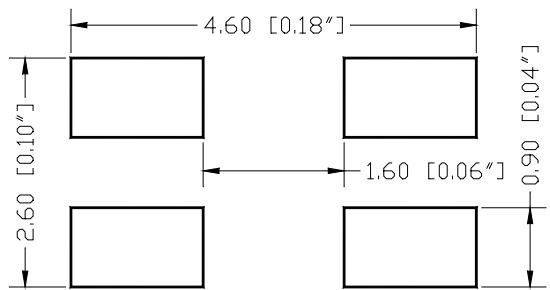


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## PACKAGING DIMENSIONS



## RECOMMEND PAD LAYOUT





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## Typical Electro-Optical Characteristics Curve:

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Fig 1. Forward Current vs. Forward Voltage

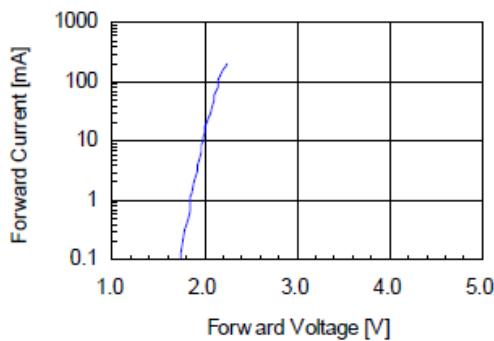


Fig 2. Relative Intensity vs. Forward Current

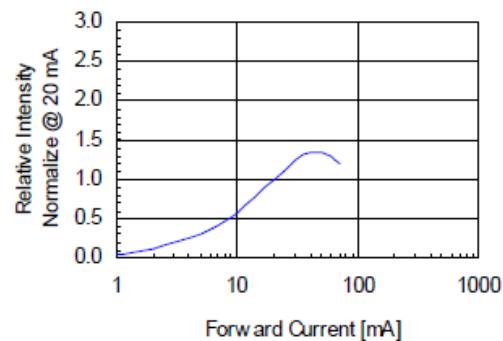


Fig 3. Forward Voltage vs. Temperature

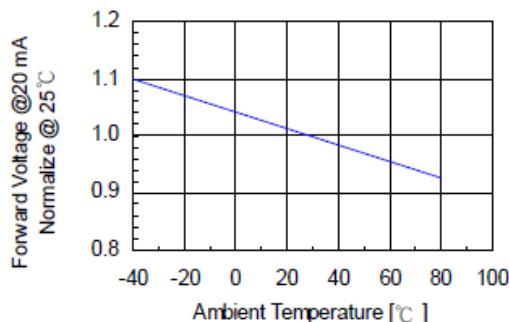


Fig 4. Relative Intensity vs. Temperature

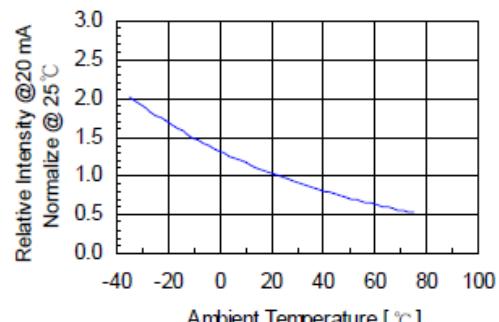
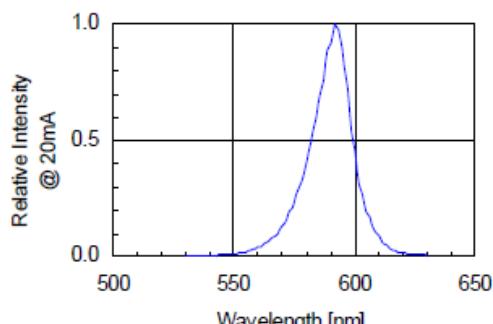
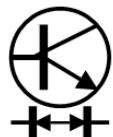


Fig 5. Relative Intensity vs. Wavelength

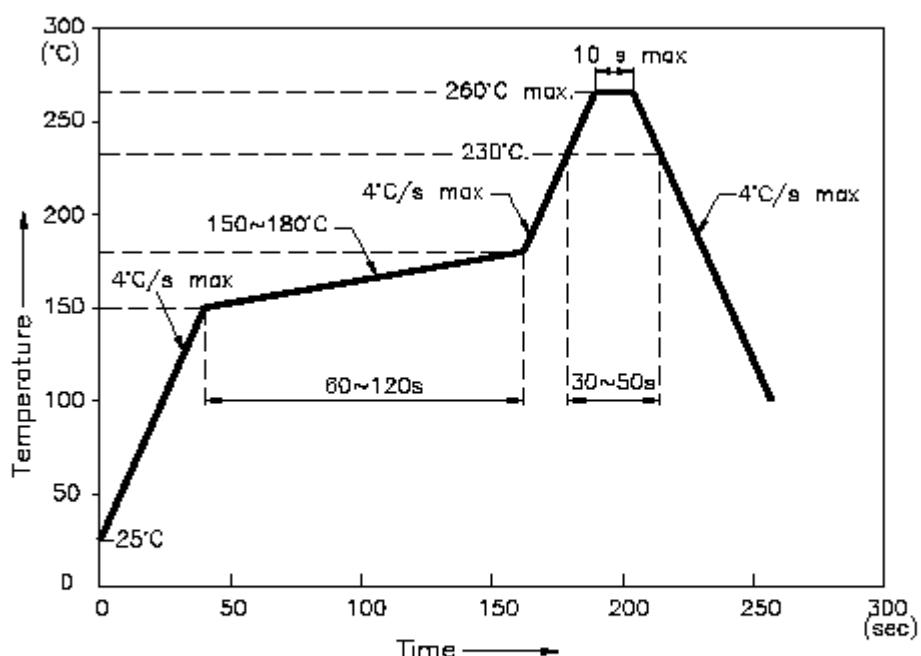




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## Soldering Profile

Reflow Soldering Profile For Lead-free SMT Process.



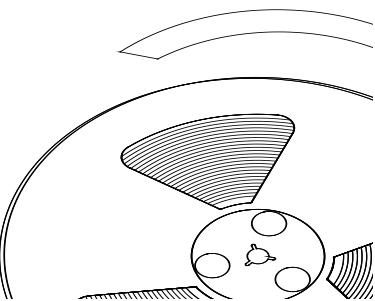
### NOTES:

1. We recommend the reflow temperature  $245^{\circ}\text{C} (+/- 5^{\circ}\text{C})$ . The maximum soldering temperature should be limited to  $260^{\circ}\text{C}$ .
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

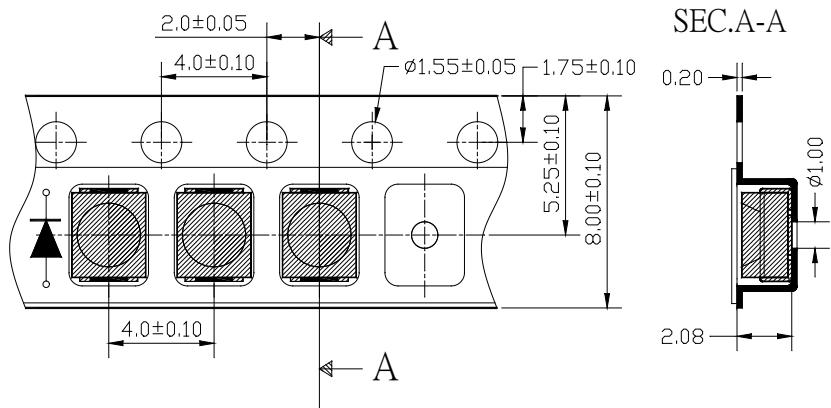


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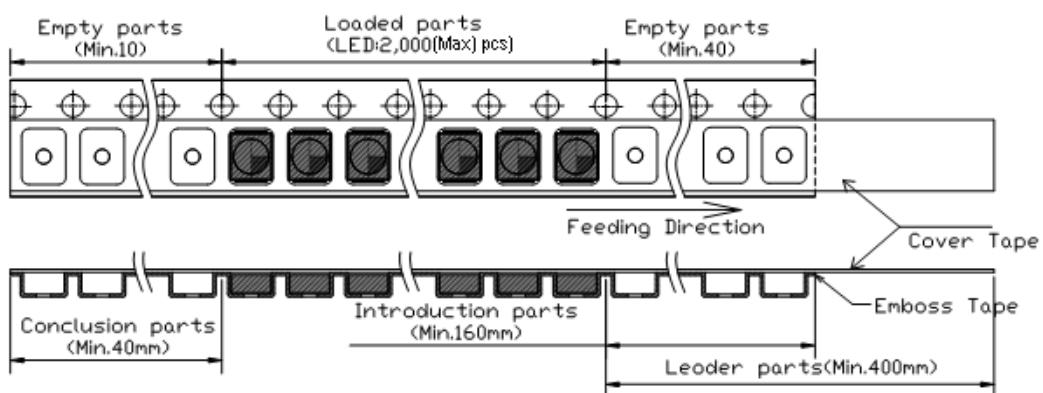
### ■Feeding Direction



### ■Dimensions of Tape (Unit: mm)



### ■Arrangement of Tape



Notes:

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing lamps is two;
3. The cathode is oriented towards the tape sprocket hole;
4. 2,000pcs/Reel